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THE MERCHANT EMBEDDED COMPUTING MARKET 2011 EDITION

**A Strategic Report on the Latest
Embedded Computing Technologies
Plus Forecasts of Key Markets**

Report Highlights

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The Merchant Embedded Computing Market - 2011 Edition

Synopsis

The Merchant Embedded Computing Market - 2011 Edition report analyzes the performance of the industry from 2002 - 2015. Although, there are several hundred companies, most are fairly small in revenue and highly specialized, focusing on specific application segments with unique product requirements. The report tracks and analyzes four application markets, nine bus architectures and four form factors. Specific trends and issues of the forecast by application, bus architecture and form function are covered in detail in the report.

Whereas the overall MEC market is slowly recovering from the trauma of 2009's economic meltdown, the performance of various market segments, bus architectures, and companies will recover at different rates. Total revenue was just under \$5 billion in 2010, a 4 percent increase from 2009 revenue which had a 12-14 percent decrease over 2008. If the economies worldwide hold together, the MEC industry will likely recover at about 6 percent in 2011 to ~\$5.2 billion.

The MEC report targets five specific application markets: Communications, Industrial, Medical, Military/aerospace and an Other category that includes transportation, security, surveillance, point-of-sale/kiosk applications, etc. The Communication wireless segment is being driven by smart phone traffic. 3G/4G services are where the money is for carriers going forward and the wireline and optical networks are gearing up for upgrades to support the ever increasing traffic. Industrial got hammered down with the financial crisis that also took its toll aerospace, and automotive that use MEC systems to automate productions testing and process control.

The Medical segment was hit hard by the financial crisis which made purchasing MEC-based, large equipment much more difficult. The ever healthy Mil/Aero segment also caught the financial virus and is facing a rapidly declining defense department budget in the USA that is likely to cause a restructuring not seen since the end of the cold war.

Each architecture has a different rate of adoption depending on the needs of individual application segments. Overall key trends are "Power is up and down; Green is the new color; and small is big". New 40 and 32-nm silicon for microprocessors, graphics, DSPs and high integration I/O chips pack a lot of processing power while greatly reducing power consumption. High integration silicon and serial buses enable more small form factors (SFF) than in the past and are making many older, parallel bus structures, such as PCI, look like the bus architecture equivalent of a "clunker". Bus structures continue to proliferate around the major and long established busses but the number of variances is past 100.

The MEC industry can be separated into uses four form functions defined as: single board computers (SBC), digital signal processors (DSP) boards, I/O boards and an All Other category that incorporate a huge number of diverse and specific functions. In some applications I/O boards are proliferating and are customized to the wide spectrum of I/O functions that different applications use. In other applications, single board computers are becoming the trend as they incorporate more and more functionality with advanced silicon and draw in DSP, graphics and many advanced I/O functions.

About the Author

Brad Smith is an independent Principal Analyst for New Venture Research (NVR). Mr. Smith has an extensive background in semiconductors and electronics assembly having held senior positions in leading market research companies such as DataQuest, Gartner and RHK. He is the past founder and CEO of LuxSonar Semiconductors, Innovision Labs Semiconductors and Director and Co-Founder for NexGen Microsystems. He holds a BSEE from the University of Massachusetts and MBA course work from the University of Phoenix.

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Dialogic
Diamond Systems
DIGITAL-LOGIC
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DSM Computer
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Eurotech
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